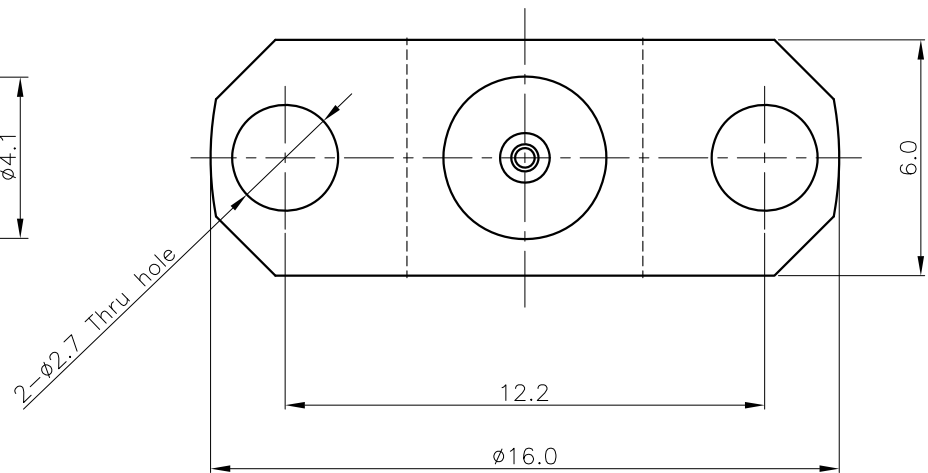
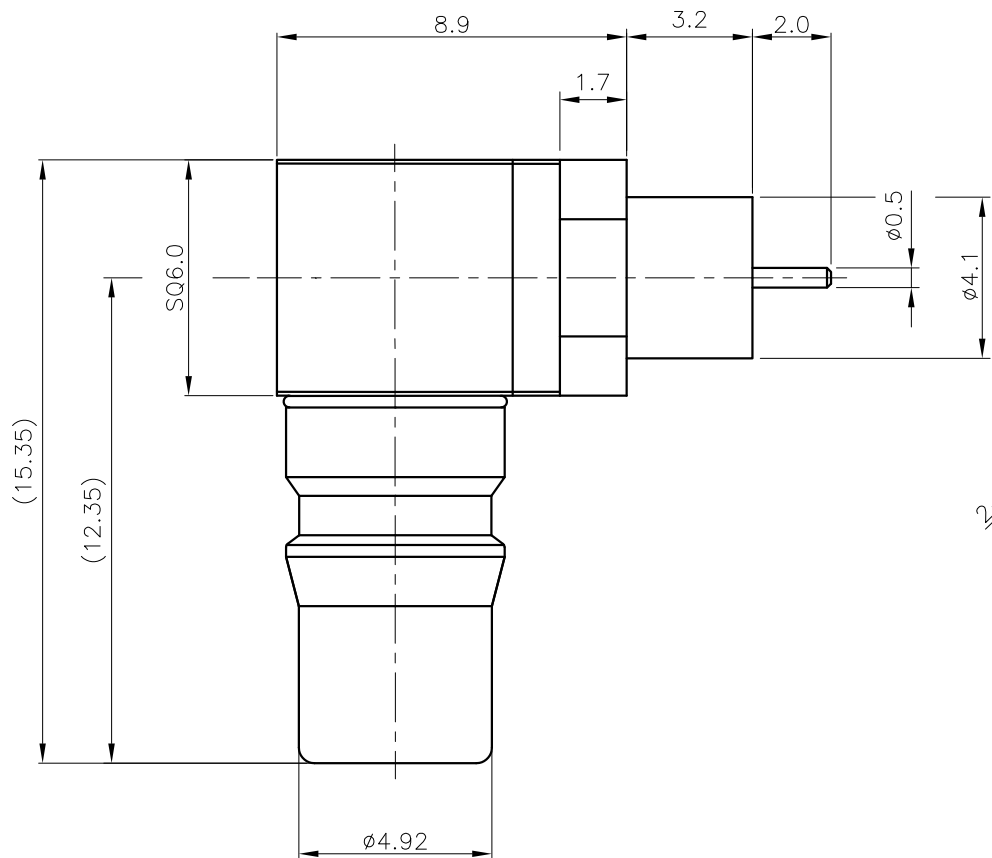


REVISION				
REV	DESCRIPTION	DRAWN	APPR	DATE
IR	Initial Registration	S.H.KIM		2024.12.26.



6	COVER	1	MBsBD C3604BD-F	Nickel Plate	DCO00026-5/1	
5	INSULATOR	1	TEFLON		DIN03413-N/1	
4	INSULATOR	1	TEFLON		DIN01265-N/2	
3	CONTACT	1	MBsBD C3604BD-F	Gold Plate	DCT01488-5/2	
2	CONTACT	1	BeCu C17300	Gold Plate	DCT01487-5/2	
1	1-2 BODY (B)	1	MBsBD C3604BD-F	Nickel Plate	DBB00145-5/5	DBD01953-1/3
	1-1 BODY (A)	1	MBsBD C3604BD-F	Nickel Plate		DBD01952-1/3
NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE	

Notes

- RoHS & Pb-FREE
- CONNECTOR MATERIAL & FINISHES
 - BODY : BRASS / Nickel Plating
 - CONTACT : Beryllium copper / Gold Plating
 - INSULATOR : TEFLON

TOLERANCE	Decimal ±0.2	DATE 2024. 12. 26.			 RF & MICROWAVE TECHNOLOGY Tel : 82-32-347-8015 Fax : 82-32-347-8017		
	Angle ±1°	APPROVED BY					
	MATERIAL -		CHECKED BY			TITLE QMA50 SOLDER END JL-2H	
FINISH -		DRAWN BY S.H.KIM					
		SCALE 5/1	UNIT mm		A4	DWG NO. CN01969-7/5	
						REVISION I R	
					SHEET 1 of 1		